

# MOS FIELD EFFECT TRANSISTOR $\mu$ PA2732UT1A

# SWITCHING P-CHANNEL POWER MOSFET

### DESCRIPTION

The  $\mu$  PA2732UT1A is P-channel MOS Field Effect Transistor designed for power management applications of notebook computers and Li-ion battery protection circuit.

#### FEATURES

- Low on-state resistance
- $R_{DS(on)1}$  = 3.7 m $\Omega$  MAX. (V<sub>GS</sub> = -10 V, I<sub>D</sub> = -20 A)
- $R_{DS(on)2}$  = 6.7 m $\Omega$  MAX. (V<sub>GS</sub> = -4.5 V, I<sub>D</sub> = -20 A)
- Low Ciss: Ciss = 3280 pF TYP.
- Small and surface mount package (8pin HVSON)

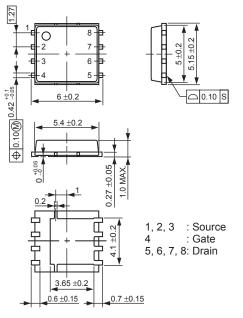
#### ORDERING INFORMATION

PART NUMBER	PACKAGE
μ ΡΑ2732UT1Α-Ε1-ΑΖ <sup>Note</sup>	8pin HVSON
μΡΑ2732UT1Α-Ε2-ΑΖ <sup>Νote</sup>	8pin HVSON

Note Pb-free (This product does not contain Pb in external electrode.)

# ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ , All terminals are connected.)

Drain to Source Voltage (VGs = 0 V)	VDSS	-30
Gate to Source Voltage (VDs = 0 V)	Vgss	∓20
Drain Current (DC)	D(DC)	∓40
Drain Current (pulse)	D(pulse)	<b>∓160</b>
Total Power Dissipation Note2	Pt1	1.5
Total Power Dissipation (PW =10 sec) Note2	Pt2	4.6
Channel Temperature	Tch	150
Storage Temperature	Tstg	–55 to +150
Single Avalanche Current Note3	las	-20
Single Avalanche Energy Note3	Eas	40



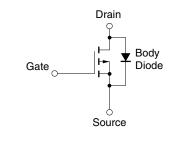
## EQUIVALENT CIRCUIT

V

V A

A W W

°C °C A mJ



**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

- 2. Mounted on a glass epoxy board (25.4 mm x 25.4 mm x 0.8 mm)
- **3.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = -15 V, R<sub>G</sub> = 25  $\Omega$ , L = 100  $\mu$ H, V<sub>GS</sub> =  $-20 \rightarrow 0$  V

**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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# PACKAGE DRAWING (Unit: mm)

ELECTRICAL (	CHARACTERISTICS (	(T <sub>A</sub> = 25°C, All t	terminals are connect	ed.)
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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	loss	$V_{DS}$ = -30 V, $V_{GS}$ = 0 V			-1	μA
Gate Leakage Current	lgss	V <sub>GS</sub> = ∓20 V, V <sub>DS</sub> = 0 V			<b>∓100</b>	nA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-1.0		-2.5	V
Forward Transfer Admittance Note	y <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -20 A	30			S
Drain to Source On-state Resistance Note	RDS(on)1	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -20 \text{ A}$		3.1	3.7	mΩ
	RDS(on)2	$V_{GS}$ = -4.5 V, I <sub>D</sub> = -20 A		4.3	6.7	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		3280		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		1310		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		560		pF
Turn-on Delay Time	td(on)	$V_{DD} = -15 \text{ V}, \text{ I}_{D} = -20 \text{ A}$		14		ns
Rise Time	tr	V <sub>GS</sub> = -10 V		15		ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 10 Ω		680		ns
Fall Time	tr			440		ns
Total Gate Charge	QG	V <sub>DD</sub> = -24 V		133		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = -10 V		14		nC
Gate to Drain Charge	Qgd	I⊳ = −40 A		41		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 40 A, V <sub>GS</sub> = 0 V		0.85	1.2	V
Reverse Recovery Time	trr	IF = 40 A, VGS = 0 V		88		ns
Reverse Recovery Charge	Qrr	di/dt = 50 A/ <i>µ</i> s		59		nC

Note Pulsed

#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

#### **TEST CIRCUIT 2 SWITCHING TIME**

≶r∟ 1

VDD

VGS(-)

VDS(-)

VDS

0

td(on

0 <u>10</u>%

VGS Wave Form

VDS

Wave Form

90%

90%

† f

toff

Vgs

10% 10%

tr to

D.U.T.

0

 $\sim$ 

RG

PG.

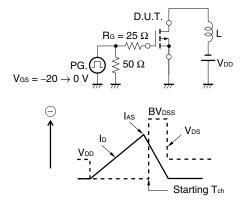
τ

Duty Cycle ≤ 1%

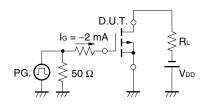
 $\tau = 1 \, \mu s$ 

Vgs(-)

0 -

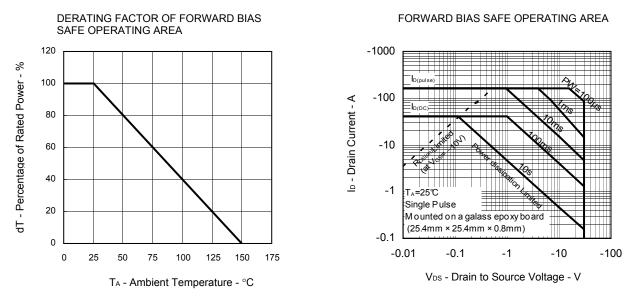


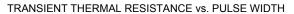
#### **TEST CIRCUIT 3 GATE CHARGE**

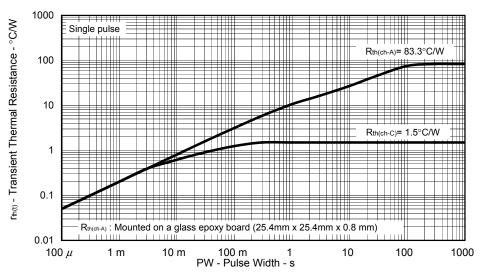


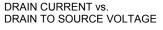
Downloaded from Elcodis.com electronic components distributor

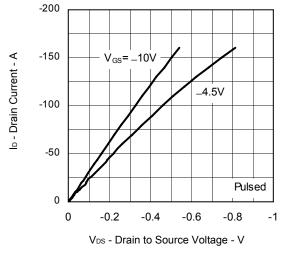
### TYPICAL CHARACTERISTICS (TA = 25°C)



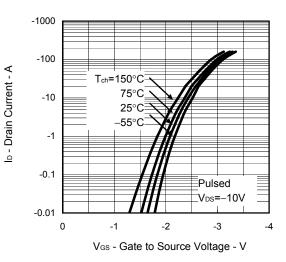




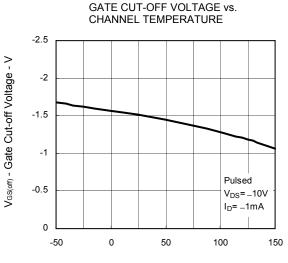




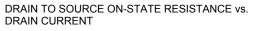
FORWARD TRANSFER CHARACTERISTICS

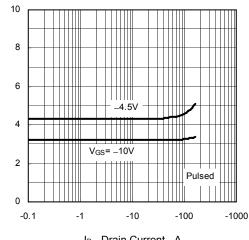


Data Sheet G17641EJ1V1DS



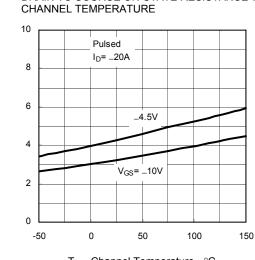
Tch - Channel Temperature - °C





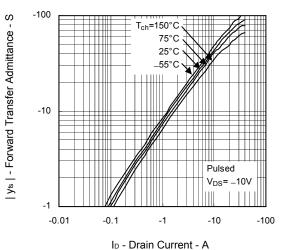
ID - Drain Current - A

DRAIN TO SOURCE ON-STATE RESISTANCE vs.

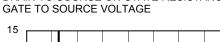


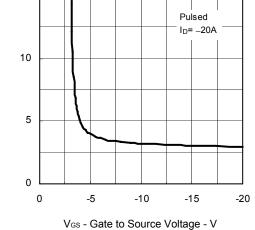


FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

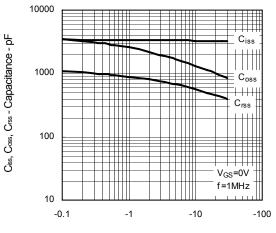


DRAIN TO SOURCE ON-STATE RESISTANCE vs.





CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



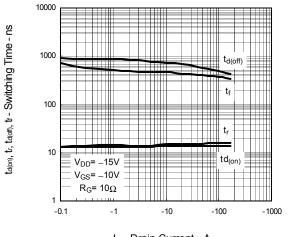
VDS - Drain to Source Voltage - V

 $R_{DS(or)}$  - Drain to Source On-state Resistance -  $m\Omega$ 

 $R_{DS(on)}$  - Drain to Source On-state Resistance - m $\Omega$ 

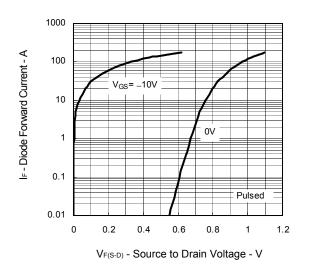
 $R_{DS(on)}$  - Drain to Source On-state Resistance -  $m\Omega$ 

SWITCHING CHARACTERISTICS



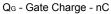
ID - Drain Current - A



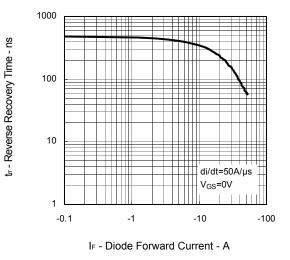


 $\begin{array}{c} -12 \\ -10 \\ -10 \\ -8 \\ -6 \\ -6 \\ -4 \\ -2 \\ 0 \\ 0 \\ 50 \\ 100 \\ 150 \end{array}$ 

DYNAMIC INPUT CHARACTERISTICS



REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



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